

MCS Series DATA SHEET

PN: 602346038, Model: C6-S7-3070-MCS-15-560-470-SX-1G-660-3R



The Modular 3D Compact Sensor (MCS) from AT - Automation Technology is revolutionizing 3D image processing with its unique modularity, flexibility and high performance. This innovative system allows individual configuration in terms of scan width, measurement accuracy, speed, triangulation angle and working distance to perfectly match the needs of specific applications. With an unprecedented profile speed of 200 kHz and a resolution of 4096 points per profile, the MCS sets technological standards. It overcomes traditional hurdles such as high NRE costs and long development times by combining the reliability of a series product with the flexibility of a customized solution, without additional costs or minimum order quantities.

- **Freely configurable, factory-calibrated modular 3D sensors for individual solutions**
- **Five triangulation angles available (15, 20, 25, 30, 40)**
- **Four different sensor resolutions available (1280, 2040, 3070, 4090)**
- **No extra costs, long delivery times or minimum order quantities**
- **Available with different laser classes and wavelengths**



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Model Information

Model Name	C6-S7-3070-MCS-15-560-470-SX-1G-660-3R
Part Number	602346038

General Data

Points per Profile	3072
Triangulation Angle	15 °
Working Distance	473 mm
Laser Safety Class	3R
Laser Wavelength	660 nm
Laser Output Power	-
Laser Line Width	-
Linearity Z-Axis	0.06 % of calibrated Z-Range
Profile speed with 200-row region	4798 Hz
Maximum profile speed	66489 Hz

Field of View

	Nominal	Near Field	Far Field
Scan Width	561.7 mm	379.4 mm	807.5 mm
X-Resolution	182.8 µm	123.5 µm	262.9 µm
Z-Resolution	12.9 µm	-	-

Z-Range

	Full	Near Field	Far Field
Z-Range	365 mm	155 mm	209.8 mm

Technical Specifications

Interface	Gigabit-Ethernet (1GigE)
Inputs	Encoder A+, A-, B+, B-, Z+, Z- (TTL level) Two freely configurable digital inputs (+5 to +24 VDC)
Outputs	Two freely configurable digital outputs (+5 to +24 VDC)
Power Supply	Sensor supply +10 to +24 VDC (max. +27 VDC) Laser supply +10 to +24 VDC
Housing	Anodized aluminum IP67 certified
Weight	-
Environmental Conditions	Operating temperature: 0 to +40 °C Storage temperature: -20 to +80 °C Relative humidity: 20 to 80 % (non-condensing)
Vibration Resistance	Sinusoidal: DIN EN 60068-2-6:2008-10: 2g, 10-150 Hz Random: DIN EN 60068-2-64:2020-09: 7g, 10-500 Hz
Shock Resistance	DIN EN 60068-2-27: 2010-02: 15g, 3ms
Supported Standards	GenICam GigEVision
Firmware Features	RegionTracking, RegionSearch, Multiple Regions, MultiPart, AutoStart, HistoryBuffer, MultiSlope, MultiPeak
Software	SolutionPackage, MetrologyPackage, cxSDK for C, C++, .Net, Python, Matlab, Halcon

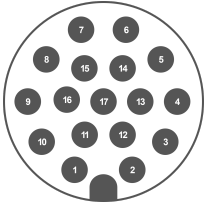

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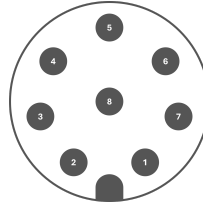
Connector layout and pin assignment

Power & I/O Connector: M12 17-Pin A-Coded Male



1	Z-	Encoder input Z- (RS-422)
2	AOUT	Analog output (0-5 V)
3	Z+	Encoder input Z+ (RS-422)
4	B+	Encoder input B+ (RS-422)
5	GND	Sensor supply ground, reference for AOUT
6	B-	Encoder input B- (RS-422)
7	A-	Encoder input A- (RS-422)
8	VCC	Sensor supply voltage (12-24 V DC)
9	GND	Sensor supply ground, reference for AOUT
10	A+	Encoder input A+ (RS-422)
11	ENC_GND	Encoder reference ground
12	OUT2	Digital output 2, level defined by OUT-VCC
13	IN1	Digital input 1 (5-24V DC)
14	IN2	Digital input 2 (5-24V DC)
15	OUT_Supply	Optional output supply voltage (5-24V DC), refers to IO-GND
16	OUT1	Digital output 1, level defined by OUT-VCC
17	IO_GND	Reference ground for digital inputs and outputs
Shield	SHIELD	Connected to device housing

Ethernet Connector: M12 8-Pin A-Coded Female



1	BI_DC-
2	BI_DD+
3	BI_DD-
4	BI_DA-
5	BI_DB+
6	BI_DA+
7	BI_DC+
8	BI_DB-
Shield	SHIELD